| 6/08 (DEC 1 6 2008) | 0000 | FUJ-026A | |
|--|---|--|--|
| FORM PTO-15% | -2008 | U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office | |
| To the Honorable Commissioner on 10354 | 10499 | ed original documents or copy thereto: | |
| 1. Name of conveying party(ies): | 2. Name and | address of receiving party(ies): | |
| 1. Akira MOROZUMI | | FUJI ELECTRIC DEVICE TECHNOLOGY CO., LTD. | |
| Shin SOYANO Yoshikazu TAKAHASHI | Street Address: City: | 11-2 Osaki 1-chome, Shinagawa-ku, | |
| | State: | Tokyo | |
| 3. Nature of conveyance: | Zip: | 141-0032 | |
| ⊠ Assignment □ Merger | Country: | Japan | |
| □ Security Agreement □ Change of Name □ Other | | | |
| | | & address(es) attached? □ Yes ⊠ No | |
| 4. Application number(s) or patent number(s):If the document is being filed together with a new application, tA. Patent Application No(s). | he execution date of the B. Patent No(s). | application is: | |
| 12/213,923 filed June 26, 2008 «PATENT» «ISSUED» | | SUED» | |
| Additional numbers a | ttached? 🗖 Yes 🗶 No | | |
| 5. Name and address of party to whom correspondence | 6. Total number o | 6. Total number of applications and patents involved: one | |
| concerning document should be mailed: Name: | 7. Total fee (37 CFR 3.41) <u>\$40.00</u> | | |
| KANESAKA BERNER & PARTNERS | Enclosed Authorized to be charged to deposit account | | |
| Internal Address: | | ayment form enclosed | |
| Internal Address. | 8. Deposit account number: | | |
| Street Address: 1700 Diagonal Road, Suite 310 | | | |
| City: Alexandria State: VA Zip: 22314 | | | |
| DO NOT US | SE THIS SPACE | | |
| 9. Signature. Manabu kanesaka, No. 31,467 | Ain Kan | cic December 16, 2008 | |
| Name of Person, Registration No. | Signature | Date | |
| | Total number of | pages including cover sheet, attachment | |
| Total number of pages including cover sheet, attachment, and document: | and document: | 2/17/2008 SNOHAMM1 00000053 12213923 | |

PATENT REEL: 022026 FRAME: 0730

ASSIGNMENT

For value received, we, (1) Akira Morozumi; (2) Shin Soyano; and (3) Yoshikazu Takahashi having post office address at (1), (2) and (3) c/o Fuji Electric Device Technology Co., Ltd, 11-2 Osaki 1-chome, Shinagawa-ku, Tokyo, 141-0032, Japan hereby sell, assign and transfer to Fuji Electric Device Technology Co., Ltd a corporation existing under the laws of located at 11-2 Osaki 1-chome, Shinagawa-ku, Japan Tokyo, 141-0032, Japan and its successors, assigns, and legal representatives the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to METHOD FOR PRODUCING A SEMICONDUCTOR DEVICE USING A SOLDER described in application for Letters Patent of the United ALLOY States, Serial No. 12/213,923 Filed June 26, 2008 and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I/We have full right so to do, and agree that I/We will communicate to said Company or its representatives any facts known to me/us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Page 1 of 2

| Signature | |
|-----------|--|

| $\Omega $ | Λ | κ |
|-----------|-----------|-----|
| Ukita | noros | run |
| | / | |

Date 12/11/2008

Akira MOROZUMI

Shin SOYANO

signature Shim Soyano Date 12/11/2008

Date 12/11/2008

Signature <u>Joshihan</u> Takahashi Yoshikazu TAKAHASHI

Page 2 of 2

\$

PATENT REEL: 022026 FRAME: 0732

| DEC 1 6 2008 | łΕ | UNITED STATES PATENT AND TRADEMARK OFFICE FUJ-026A |
|----------------|----|--|
| Applicant | : | Akira MOROZUMI et al. |
| Title | : | METHOD FOR PRODUCING A SEMICONDUCTOR DEVICE USING A SOLDER ALLOY |
| Serial No. | : | 12/213,923 |
| Filed | : | June 26, 2008 |
| Group Art Unit | : | |
| Examiner | : | |

Hon. Commissioner of Patents P.O. Box 1450, Alexandria, VA 22313-1450

December 16, 2008

SUBMISSION OF ASSIGNMENT

Sir:

Submitted herewith is an assignment assigning the application to FUJI ELECTRIC DEVICE TECHNOLOGY CO., LTD.

Attached herewith is a credit card authorization form to cover the recording fee of an assignment in the amount of \$40.00.

> Respectfully submitted, KANESAKA BERNER & PARTNERS

by 16 Manabu Kanesa

Reg. No. 31,467 Agent for Applicants

1700 Diagonal Road, Suïte 310 Alexandria, VA 22314, (703)519-9785 MAN/fs

RECORDED: 12/16/2008